SPECIFICATION:

Product Model: BF12120-01(1024768)

DESIGNED	CHECKED	Approved
研发部	研发部	研发部
2018.07.18	2018.07.18	2018.07.18
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Approval by Customer:

Ok	
NG, Problem survey	
Approved By	

Revision Record

		CONTENTS	Note
V0	2018.07.18	NEW ISSUE	

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1. Scope

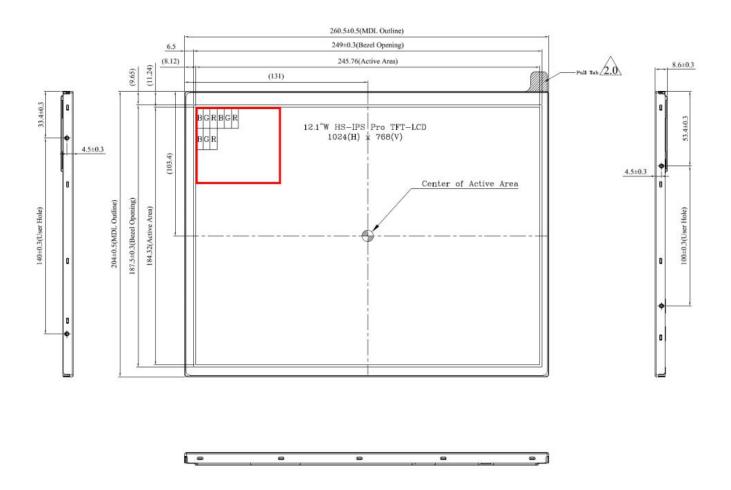
This specification defines general provisions as well as inspection standards for TFT module supplied by BOCEN.

If the event of unforeseen problem or unspecified items may occur, naturally shall negotiate and agree to solution

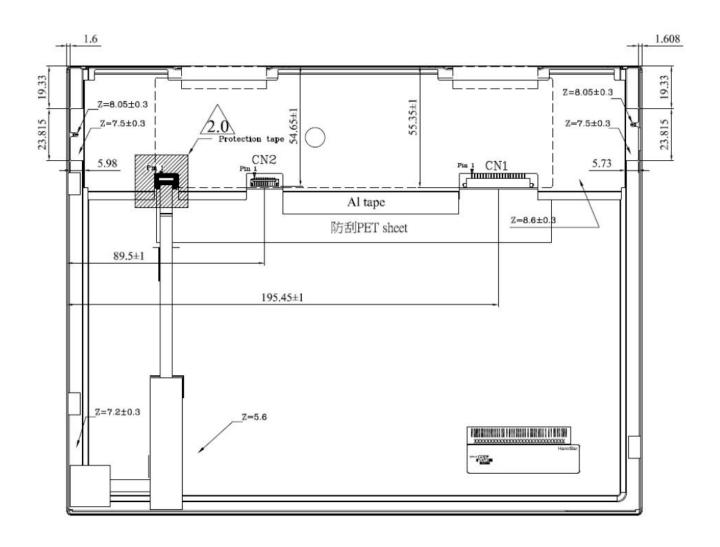
2. General Information

ITEM	STANDARD VALUES	UNITS
LCD type	12.1"TFT	
Dot arrangement	1024×3 (RGB)×768	dots
Color filter array	RGB vertical stripe	
Display mode	Normally BLACK	
Viewing Direction	ALL VIEW	
Module size	260(W)×204(H)×8.6(T)	mm
Active area	245.76(W)×184.32(H)	mm
Dot pitch	0.24(W)×0.24(H)	mm
Interface	LVDS	
Operating temperature	-30 ~ +85	°C
Storage temperature	-30 ~ +85	°C
Module Weight	520	g

3. External Dimensions



General tolerance: ±0.5mm



4. Interface Description

LCM CONNECTOR: STARCONN 076B20-0048RA-G4 or JAE FI-SEB20P-HFE (or equivalent)

No.	Symbol	I/O	Function			
1	RXIN3+	I	Positive LVDS differential data inputs			
2	RXIN3-	I	Negative LVDS differential data inputs			
3	BIST	I	Normal operation/BIST pattern select. BIST="1" : BIST mode. BIST="0" : Normal operation.			
4	SELB	I	6bit/8bit mode select H : 8bit / L : 6bit			
5	GND	Р	Ground			
6	RXCLK+	I	Positive LVDS differential clock inputs			
7	RXCLK-	I	Negative LVDS differential clock inputs			
8	GND	Р	Ground			
9	RXIN2+	I	Positive LVDS differential data inputs			
10	RXIN2-	I	Negative LVDS differential data inputs			
11	GND	Р	Ground			
12	RXIN1+	I	Positive LVDS differential data inputs			
13	RXIN1-	I	Negative LVDS differential data inputs			
14	GND	Р	Ground			
15	RXIN0+		Positive LVDS differential data inputs			
16	RXIN0-	I	Negative LVDS differential data inputs			
17	L/R	I	Horizontal inversion			
18	U/D	I	Vertical inversion			
19, 20	VDD	Р	Digital power			

I: input, O: output, P: Power

[Note]

*1): When L/R="0", set left to right scan direction

When L/R="1", set right to left scan direction When U/D="0", set bottom to top scan direction

When U/D="1", set top to bottom scan direction

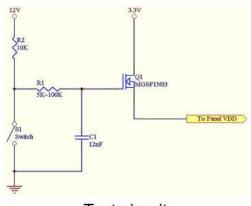
Backlight pin Assignment(cn2): ACES 91208-01001-H01 (or equivalent)

No.	Symbol	Description	Function
1~4	Vi	Converter input voltage	12V
5-8	GND	Ground	Ground
9	EN	Enable pin	3.3V
10	ADJ	Backlight Adjust	PWM Dimming (100Hz-30KHz, Hi: 2.0~3.3V,Lo: 0~0.8V)

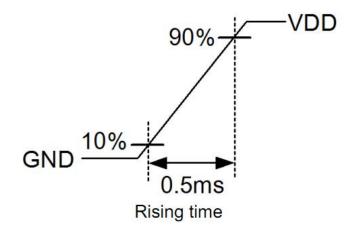
5. ELECTRICAL CHARACTERISTICS

Item	Symbol	Min.	Тур.	Max.	Unit	Note
Supply Voltage	V_{DD}	3.0	3.3	3.6	V	
Current of power supply	I _{DD}	<u> </u>	0.25	8 <u>0—8</u> 9	Α	V _{DD} =3.3V · white pattern (L255)
VDD Power	P _{DD}		0.8	1.2	W	V _{DD} =3.3V · white pattern (L255)
Inrush current	I _{RUSH}	1 <u>0</u>	==	2.0	Α	Note*

Note*: Inrush current test circuit and rising time setting (power on)



Test circuit

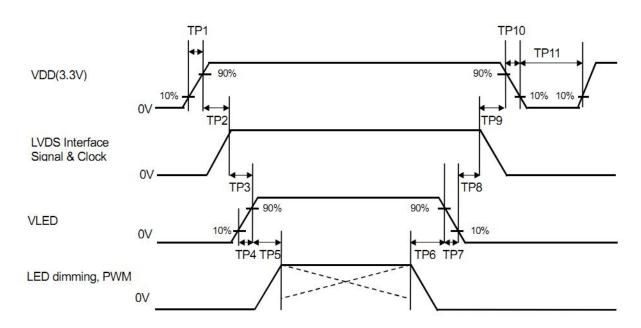


6. Switching Characteristics for LVDS Receiver

Item	Symbol	Min.	Тур.	Max.	Unit	Conditions
Differential Input High Threshold	V _{TH}	100	21	300	mV	
Differential Input Low Threshold	V _{TL}	-300	-1	100	mV	
Differential input common mode voltage	V _{CM}	1.0	1.2	1.7- V _{ID} / 2	V	
Input Current	I _{IN}	-10	-	10	uA	RX+/-, RXC+/-
Differential input Voltage	V _{ID}	200	-1	600	mV	

7. Timing Characteristics

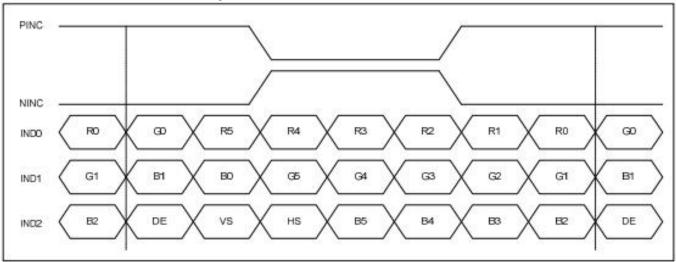
7.1 POWER ON/OFF SEQUENCE



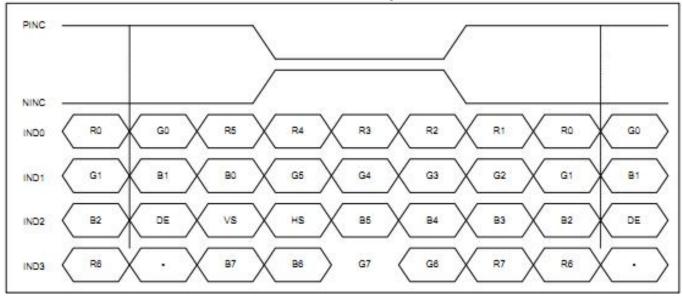
Item	Min.	Тур.	Max.	Unit
TP1	0.5		10	msec
TP2	0		50	msec
TP3	200		100	msec
TP4	0.5		10	msec
TP5	10			msec
TP6	10	-		msec
TP7	0	-	10	msec
TP8	200	-	New York	msec
TP9	0		50	msec
TP10	1		10	msec
TP11	1000			msec

7.2 INPUT SIGNAL TIMING

7.2.1 LVDS mode data input format



6-bit LVDS input

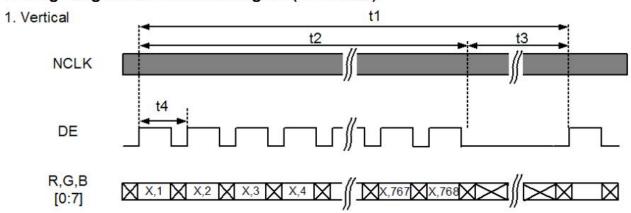


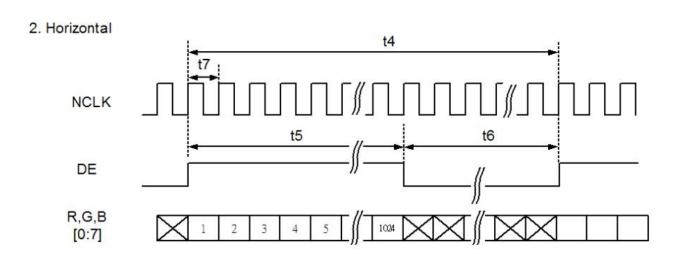
8-bit LVDS input

7.2 PARALLEL RGB INPUT TIMING TABLE DE mode (1024x768)

Item	Symbol	Min.	Тур.	Max.	Unit
Frame Rate		59.95	60.05	60.15	Hz
Vertical Total Time	Tv	774	776	778	line
Vertical Display Time	TVD		768	20.	line
Vertical Blanking Time	TVB	6	8	10	line
Horizontal Total Time	Тн	1084	1088	1092	clock
Horizontal Display Time	Тно		1024		clock
Horizontal Blanking Time	Тнв	60	64	68	clock
Clock Rate	1/ Tclock	50.3	50.7	51.1	MHz

Timing Diagram of Interface Signal (DE mode)





8. Backlight Backlight Unit

Item	Symbol	MIN	TYP	MAX	UNIT	Test Condition		
Input Current	Vf	10	12	16	Volt	Ta=25℃		
Input Voltage	If	-	850	1200	mA	Ta=25℃		
White luminance		400	600		Cd/cm2	850mA		
Uniformity for LCM	-	75	-	-	%	Ta=25℃		
LED Life-Time	-	-	30000	-	Hr	Ta=25℃		

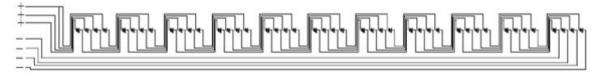
Backlight DC Electrical Characteristics

Parameter	Symbol	Min	Тур	Max	Units	Note
Backlight Power Supply	Vi	10	12	16	Volt.	
LED_EN High Threshold	VENH	1.4	3.3	5.0	Volt.	
LED_EN Low Threshold	V _{ENL}	0	-	8.0	Volt.	
PWM High Threshold	V _{PWMH}	2.0	3.3	6.0	Volt.	
PWM Low Threshold	VPWML	0	122	0.8	Volt.	
PWM Frequency	F _{PWM}	100	(-1	30K	Hz	Note (4)
PWM Duty Cycle	TD	10		100	%	Note (4)

Note (1) LED life time (Hr) can be defined as the time in which it continues to operate under the condition: Ta=25±3 °C, typical IL value indicated in the above table until the brightness becomes less than 50%.

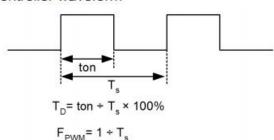
Note (2) The "LED life time" is defined as the module brightness decrease to 50% original brightness at Ta=25°C and I_i=850mA, the LED lifetime could be decreased if operating IL is larger than 850mA. The constant current driving method is suggested.

Note (3) LED Light Bar Circuit



BLU circuit: 11S-4P

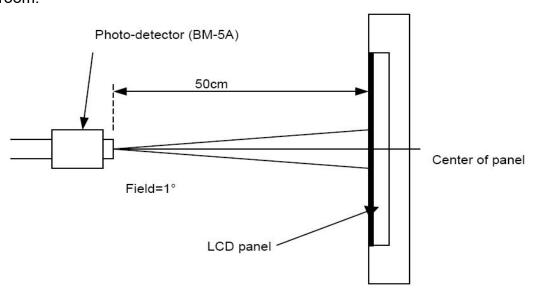
Note (4) Dimming controller waveform

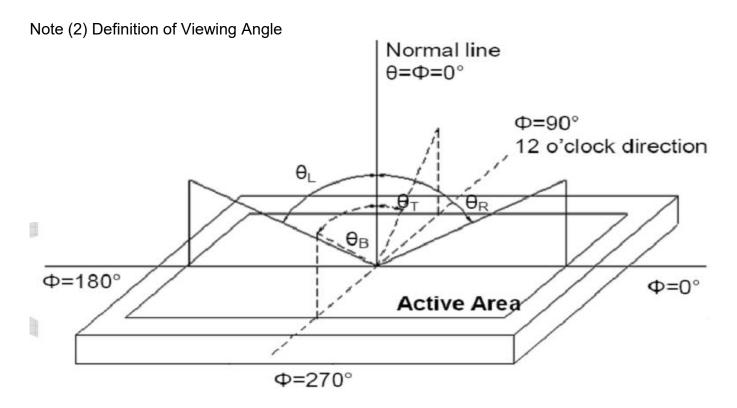


9. Optical Characteristics

Item	Condition	s	Min.	Тур.	Max.	Unit	Note	
	Horizontal g Angle	θL	-	85	-	degree		
Viewing Angle		θR	-	85	-		(1),(2),(6)	
(CR>10)	\	θт	-	85	-			
	Vertical	θв	-	85	-			
Contrast Ratio	Center		-	900	-	-	(1),(3),(6)	
Response Time	Rising + Fal	ling	-	40	-	ms	(1),(4),(6)	
	Red x					-		
	Red y				Typ. +0.05	-		
	Green x					-		
CF Color	Green y		Тур.			-	(1) (6)	
Chromaticity (CIE1931)	Blue x		-0.05			-	(1), (6)	
(Blue y					-		
	White x			0.290		-		
	White y			0.325		-		

Note (1) Measurement Setup: The LCD module should be stabilized at given temp. 25°C for 15 minutes to avoid abrupt temperature change during measuring. In order to stabilize the luminance, the measurement should be executed after lighting backlight for 15 minutes in a windless room.



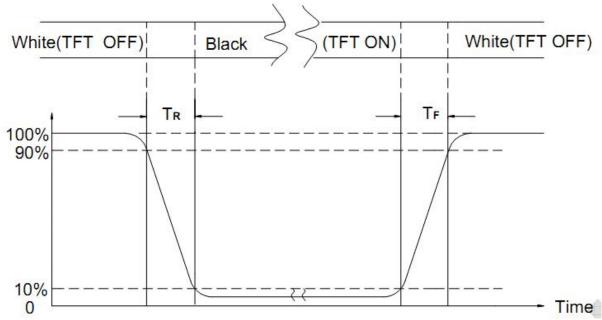


Note (3) Definition of Contrast Ratio (CR)

The contrast ratio can be calculated by the following expression Contrast Ratio (CR) = L63 / L0

L63: Luminance of gray level 63, L0: Luminance of gray level 0

Note (4) Definition of response time



Note (5) Definition of Transmittance (Module is without signal input)

Transmittance = Center Luminance of LCD / Center Luminance of Back Light x 100%

Note (6) Definition of color chromaticity (CIE1931)

Color coordinates measured at the center point of LCD

10. Reliability Test Conditions and Methods

No.	Item	Conditions	Remark
1	High Temperature Storage	Ta=+85°C, 240hrs	
2	Low Temperature Storage	Ta=30°C, 240hrs	
3	High Temperature Operation	Ta=+85°C, 240hrs	
4	Low Temperature Operation	Ta=-30°C, 240hrs	
5	High Temperature and High Humidity (operation)	Ta=+65°C, 90%RH, 240hrs	
6	Thermal Cycling Test (non operation)	-30°C(30min) → +85°C(30min), 500 cycles	
7	Electrostatic Discharge	±200V,200pF(0Ω) 1 time/connector	
8	Vibration	1.Random: 1.04G, 5~500Hz, XYZ, 30min/each direction 2.Sine: Freq.1.5G, 8~33.3Hz, Stoke: 1.3mm Sweep: 2.9G, 33.3~400Hz X/Z: 2hrs, Y: 4hrs	
9	Shock	Half-Sine, 100G, 6ms, ±XYZ, 3time	
10	Vibration (with carton)	Random: 0.015G^2/Hz, 5~200Hz -6dB/Octave, 200~400Hz XYZ 各方向 2hrs	
11	Drop (with carton)	Drop height condition, basis on the product weight and follow QB100-0027 1 corner, 3 edges, 6 surfaces	

Note: There is no display function NG issue occurred, all the cosmetic specification is judged before the reliability stress.

11. Inspection Standard

11.1. QUALITY:

THE QUALITY OF GOODS SUPPLIED TO PURCHASER SHALL COME UP TO THE FOLLOWING STANDARD.

11.1.1. THE METHOD OF PRESERVING GOODS

AFTER DELIVERY OF GOODS FROM AMSON TO PURCHASER. PURCHASER SHALL CONTROL THE LCM AT -10 °C TO 40 °C ,AND IT MIGHT BE DESIRABLE TO KEEP AT THE NORMAL ROOM TEMPERATURE AND HUMIDITY UNTIL INCOMING INSPECTION OR THROWING INTO PROCESS LINE.

11.1.2. INCOMING INSPECTION

(A) THE METHOD OF INSPECTION

IF PURCHASER MAKE AN INCOMING INSPECTION, A SAMPLING PLAN SHALL BE APPLIED ON THE CONDITION THAT QUALITY OF ONE DELIVERY SHALL BE REGARDED AS ONE LOT.

(B) THE STANDARD OF QUALITY

ISO-2859-1 (SAME AS MIL-STD-105E), LEVEL II SINGLE PLAN.

CLASS	AQL(%)
CRITICAL	0.4 %
MAJOR	0.65 %
MINOR	1.5 %
TOTAL	1.5 %

EVERY ITEM SHALL BE INSPECTED ACCORDING TO THE CLASS.

(C) MEASURE

IF AS THE RESULT OF ABOVE RECEIVING INSPECTION, A LOT OUT IS DISCOVERED. PURCHASER SHALL BE INFORM SELLER OF IT WITHIN SEVEN DAYS. BUT FIRST SHIPMENT WITHIN FOURTEEN DAYS.

11.1.3. WARRANTY POLICY

AMSON WILL PROVIDE ONE-YEAR WARRANTY FOR THE PRODUCTS ONLY IF UNDER SPECIFICATION OPERATING CONDITIONS. AMSON WILL REPLACE NEW PRODUCTS FOR THESE DEFECT PRODUCTS WHICH UNDER WARRANTY PERIOD AND BELONG TO THE RESPONSIBILITY OF AMSON.

11.2. CHECKING CONDITION

- 11.2.1. CHECKING DIRECTION SHALL BE IN THE 45 DEGREE AREA TO FACE THE SAMPLE.
- 11.2.2. CHECKER SHALL SEE OVER 300±25 mm. WITH BARE EYES FAR FROM SAMPLE AND USING 2 PCS. OF 20W FLUORESCENT LAMP.

11.3. INSPECTION PLAN:

CLASS	ITEM	JUDGEMENT	CLASS
PACKING &	OUTSIDE AND INSIDE PACKAGE	"MODEL NO.", "LOT NO." AND "QUANTITY" SHOULD INDICATE ON THE PACKAGE.	Minor
INDICATE	2. MODEL MIXED AND QUANTITY	OTHER MODEL MIXEDREJECTED QUANTITY SHORT OR OVERREJECTED	Critical
	3. PRODUCT INDICATION	"MODEL NO." SHOULD INDICATE ON THE PRODUCT	Major
ASSEMBLY	4. DIMENSION, LCD GLASS SCRATCH AND SCRIBE DEFECT.	ACCORDING TO SPECIFICATION OR DRAWING.	Major
	5. VIEWING AREA	POLARIZER EDGE OR LCD'S SEALING LINE IS VISABLE IN THE VIEWING AREAREJECTED	Minor
	6. BLEMISH - BLACK SPOT - WHITE SPOT IN THE LCD AND LCD GLASS CRACKS	ACCORDING TO STANDARD OF VISUAL INSPECTION(INSIDE VIEWING AREA)	Minor
APPEARANCE	7. BLEMISH - BLACK SPOT WHITE SPOT AND SCRATCH ON THE POLARIZER	ACCORDING TO STANDARD OF VISUAL INSPECTION(INSIDE VIEWING AREA)	Minor
	8. BUBBLE IN POLARIZER	ACCORDING TO STANDARD OF VISUAL INSPECTION(INSIDE VIEWING AREA)	Minor
	9. LCD'S RAINBOW COLOR	STRONG DEVIATION COLOR (OR NEWTON RING) OF LCDREJECTED. OR ACCORDING TO LIMITED SAMPLE (IF NEEDED, AND INSIDE VIEWING AREA)	Minor
	10. ELECTRICAL AND OPTICAL CHARACTERISTICS (CONTRAST: VOP: CHROMATICITY ETC.)	ACCORDING TO SPECIFICATION OR DRAWING. (INSIDE VIEWING AREA)	Critical
ELECTRICAL	11.MISSING LINE	MISSING DOT: LINE : CHARACTERREJECTED	Critical
	12.SHORT CIRCUIT- WRONG PATTERN DISPLAY	NO DISPLAY - WRONG PATTERN DISPLAY - CURRENT CONSUMPTION OUT OF SPECIFICATION REJECTED	Critical
	13. DOT DEFECT (FOR COLOR AND TE	ACCORDING TO STANDARD OF VISUAL INSPECTION	Minor

11.4	STANI	DARD OF VISUAL INSPECT	ION			
NO.	CLASS	ITEM	JUDGEMENT			
NO.	MINOR	BLACK AND WHITE SPOT FOREIGN MATERIEL DUST IN THE CELL BLEMISH SCRATCH	(A) ROUND TYPE:	unit : mm. CCEPTABLE Q'TY DISREGARD 3 (Distance>5mm) 0		
11.4.2	MINOR	BUBBLE IN POLARIZER DENT ON POLARIZER	DIAMETER $ \Phi \leq 0.2 $ $ 0.2 < \Phi \leq 0.5 $ $ 0.5 < \Phi $	unit : mm. ACCEPTABLE Q'TY DISREGARD 2 (Distance>5mm) 0		
11.4.3	MINOR	Dot Defect	Items Bright dot Dark dot Pixel Define: Pixel Pixel	ize of a defective dot over d as one defective dot. ght and unchanged in size laying under black pattern. a and unchanged in size in		

NO.	CLASS	ITEM	JUDGEMEN	T
11.4.4	MINOR	LCD GLASS CHIPPING	F. S.	Y > S Reject
11.4.5	MINOR	LCD GLASS CHIPPING	SX	X or Y > S Reject
11.4.6	MAJOR	LCD GLASS GLASS CRACK	Y Y	Y > (1/2) T Reject
11.4.7	MAJOR	LCD GLASS SCRIBE DEFECT	A + B	1. a> L/3 , A>1.5mm. Reject 2. B: ACCORDING TO DIMENSION
11.4.8	MINOR	LCD GLASS CHIPPING (ON THE TERMINAL AREA)	T	$\Phi = (x+y)/2 > 2.5 \text{ mm}$ Reject
11.4.9	MINOR	LCD GLASS CHIPPING (ON THE TERMINAL SURFACE)	TZX	Y > (1/3) T Reject
11.4.10	MINOR	LCD GLASS CHIPPING	T Z	Y > T Reject

12. Handling Precautions

12.1 Mounting method

The LCD panel of BOCEN TFT module consists of two thin glass plates with ploarizes which easily be damaged. And since the module in so constructed as to be fixed by utilizing fitting holes in the printed circuit board.

Extreme care should be needed when handling the LCD modules.

12.2 Caution of LCD handling and cleaning

When cleaning the display surface, Use soft cloth with solvent

[Recommended below] and wipe lightly

- Isopropyl alcohol
- Ethyl alcohol

Do not wipe the display surface with dry or hard materials that will damage the polarizer surface.

Do not use the following solvent:

- Water
- Aromatics

Do not wipe ITO pad area with the dry or hard materials that will damage the ITO patterns Do not use the following solvent on the pad or prevent it from being contaminated:

- Soldering flux
- Chlorine (CI), Sulfur (S)

If goods were sent without being silicon coated on the pad, ITO patterns could be damaged due to the corrosion as time goes on.

If ITO corrosion happen by miss-handling or using some materials such as Chlorine (CI), Sulfur (S) from customer, Responsibility is on customer.

12.3 Caution against static charge

The LCD module use C-MOS LSI drivers, so we recommended that you:

Connect any unused input terminal to POWER or GROUND, do not input any signals before power is turned on, and ground your body, work/assembly areas, and assembly equipment to protect against static electricity.

12.4 packing

- Module employs LCD elements and must be treated as such.
- Avoid intense shock and falls from a height.
- To prevent modules from degradation, do not operate or store them exposed direct to sunshine or high temperature/humidity

12.5 Caution for operation

- It is an indispensable condition to drive LCD's within the specified voltage limit since the higher voltage then the limit cause the shorter LCD life.
- An electrochemical reaction due to direct current causes LCD's undesirable deterioration, so that the use of direct current drive should be avoided.
- Response time will be extremely delayed at lower temperature then the operating temperature range and on the other hand at higher temperature LCD's how dark color in them. However those phenomena do not mean malfunction or out of order with LCD's, which will come back in the specified operation temperature.
- If the display area is pushed hard during operation, some font will be abnormally displayed but it resumes normal condition after turning off once.
- Slight dew depositing on terminals is a cause for electro-chemical reaction resulting in terminal open circuit.
 - Usage under the maximum operating temperature, 50%Rh or less is required.

12.6 storing

In the case of storing for a long period of time for instance, for years for the purpose or replacement use, the following ways are recommended.

- Storage in a polyethylene bag with the opening sealed so as not to enter fresh air outside in it. And with no desiccant.
- Placing in a dark place where neither exposure to direct sunlight nor light's keeping the storage temperature range.
- Storing with no touch on polarizer surface by the anything else.
 [It is recommended to store them as they have been contained in the inner container at the time of delivery from us

12.7 Safety

- It is recommendable to crash damaged or unnecessary LCD's into pieces and wash off liquid crystal by either of solvents such as acetone and ethanol, which should be burned up later
- When any liquid leaked out of a damaged glass cell comes in contact with your hands, please wash it off well with soap and water

13. Precaution for Use

13.1

A limit sample should be provided by the both parties on an occasion when the both parties agreed its necessity. Judgment by a limit sample shall take effect after the limit sample has been established and confirmed by the both parties.

13.2

On the following occasions, the handing of problem should be decided through discussion and agreement between responsible of the both parties.

- When a question is arisen in this specification
- When a new problem is arisen which is not specified in this specifications
- When an inspection specifications change or operating condition change in customer is reported to BOCEN TFT, and some problem is arisen in this specification due to the change
- When a new problem is arisen at the customer's operating set for sample evaluation in the customer site.

